

S-8474 Series

WIRELESS POWER

TRANSMITTER CONTROL IC

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The S-8474 Series is Wireless Power Transmitter Control IC, which is configured with an ON time control circuit, an OFF time control circuit, a reception detection circuit, a UVLO circuit, a high temperature detection circuit, etc.

Features

- Power supply voltage:
- Current consumption:
- UVLO detection voltage:
- t_{ON} time is settable by connecting an external resistor to the RTON pin.
- Power saving is possible by intermittent operation during standby time of a receiver module. Active time: $t_{ACT} = 5.0 \text{ ms typ.}$ Sleep time:
- TH pin detection voltage is selectable:
- Built-in reception detection circuit
- Status display function:

V_{DD} = 4.5 V to 6.5 V During operation: I_{SS1} = 200 μA typ. During standby: I_{STB} = 3.0 μ A max. $V_{UVLO_{-}} = 4.1 V \text{ typ.}$

 $t_{SLEEP} = 25.0 \text{ ms typ.}$

0.667 V, 0.577 V, 0.500 V, 0.429 V, 0.370 V

Available by connecting an external LED to the STATUS pin. Continuous operation mode: Lighting Intermittent operation mode: Lights-out High temperature protection mode: Blinking Available by connecting a thermistor to the TH pin. Ta = -40° C to $+85^{\circ}$ C

- Over temperature protection function:
- Operation temperature range:
- Lead-free (Sn 100%), halogen-free

Applications

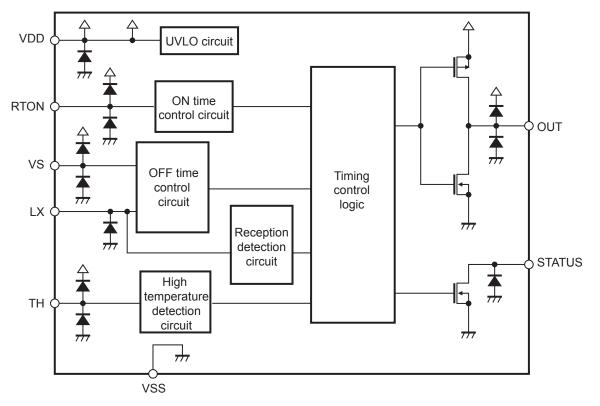
- Device for wireless power
- Small-sized wireless charging system

Package

• SNT-8A

Rev.1.2 00

Block Diagram

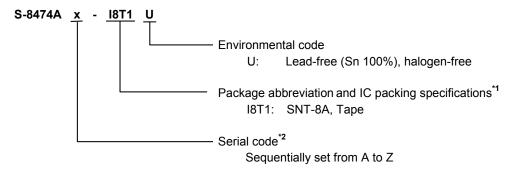


Remark All the diodes shown in the figure are parasitic diodes.

Figure 1

Product Name Structure

1. Product name



- *1. Refer to the tape drawing.
- *2. Refer to "3. Product name list".

2. Package

Table 1 Package Drawing Codes

Package Name	Dimension	Таре	Reel	Land
SNT-8A	PH008-A-P-SD	PH008-A-C-SD	PH008-A-R-SD	PH008-A-L-SD

3. Product name list

Table 2

Product Name	TH Pin Detection Voltage ^{*1} [V _{TSD}]		
S-8474AC-I8T1U	0.500 V		

*1. TH pin detection voltage is selectable: 0.667 V, 0.577 V, 0.500 V, 0.429 V, 0.370 V

Remark Please contact our sales office for products other than the above.

Pin Configuration

1. SNT-8A



Figure 2

Pin No.	Symbol	Description
1	VDD	Power supply voltage pin
2	TH	Thermistor connection pin
3	LX	Input pin for resonance circuit voltage
4	VS	Input pin for resonance circuit power supply voltage
5	STATUS	Output pin for status display
6	RTON	Resistor connection pin for ton time setting
7	VSS	GND pin
8	OUT	FET gate drive pin for resonance

Table 3

Absolute Maximum Ratings

Table 4

			(Ta = +25°C unless otherwise specified)			
Item	Symbol Applied Pin		Absolute Maximum Rating	Unit		
Input voltage between VDD pin and VSS pin	V _{DD}	VDD	$V_{\text{SS}} - 0.3$ to $V_{\text{SS}} + 7.0$	V		
Input pin voltage	V _{IN}	TH, LX, VS, RTON	$V_{SS}-0.3$ to $V_{DD}+0.3$	V		
Output pin voltage	V _{OUT}	STATUS, OUT	$V_{SS}-0.3$ to $V_{DD}+0.3$	V		
Power dissipation	PD	_	450 ^{*1}	mW		
Operation ambient temperature	T _{opr}	_	-40 to +85	°C		
Storage temperature	T _{stg}	_	-40 to +125	°C		

*1. When mounted on board

[Mounted board]

(1) Board size: 114.3 mm \times 76.2 mm \times t1.6 mm

(2) Board name: JEDEC STANDARD51-7

Caution The absolute maximum ratings are rated values exceeding which the product could suffer physical damage. These values must therefore not be exceeded under any conditions.

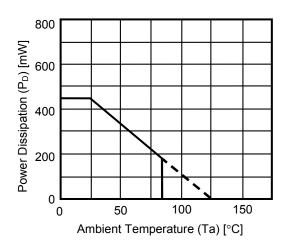


Figure 3 Power Dissipation of Package (When Mounted on Board)

WIRELESS POWER TRANSMITTER CONTROL IC S-8474 Series

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Electrical Characteristics

	$(V_{DD} = 5.0 \text{ V}, \text{ Ta} = +25^{\circ}\text{C} \text{ unless otherwise specified})$					
Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Power supply voltage	V _{DD}	_	4.5	-	6.5	V
Current consumption during operation	I _{SS1}	_	_	200	300	μA
Current consumption during standby	I _{STB}	V _{DD} = 4.0 V	_	1.0	3.0	μA
UVLO detection voltage	V _{UVLO} _	-	4.0	4.1	4.2	V
UVLO release voltage	$V_{\text{UVLO}_{+}}$	-	4.2	4.3	4.4	V
OUT pin sink current	IOUTN	V _{OUT} = 0.5 V	120	_	_	mA
OUT pin source current	I _{OUTP}	V_{OUT} = V_{DD} – 0.5 V	-	_	-120	mA
STATUS pin Nch driver ON resistance	Ronn	_	_	20	30	Ω
STATUS pin leakage current	I _{LEAKN}	V _{STATUS} = V _{DD}	-	0.1	1.0	μA
LX pin input current "H"	I _{SH_LX}	-	-0.1	-	0.1	μA
LX pin input current "L"	I _{SL_LX}	-	-0.1	-	0.1	μA
VS pin input current "H"	I _{SH_VS}	-	-0.1	-	0.1	μA
VS pin input current "L"	I _{SL_VS}	-	-0.1	-	0.1	μA
TH pin internal resistance	R _{LIN}	-	54.9	61.0	67.1	kΩ
TH pin detection voltage	V _{TSD}	-	V _{TSD} - 0.015	V _{TSD}	V _{TSD} + 0.015	V
t _{on} time	ton	R _{TON} = 1.1 MΩ	4.166	4.386	4.606	μS
Active time	t _{ACT}	_	4.5	5.0	5.5	ms
Sleep time	t _{SLEEP}	_	22.5	25.0	27.5	ms
STATUS pin blinking cycle	t _{sw}	_	54	60	66	ms
STATUS pin blinking duty	Dsw	_	47.5	50.0	52.5	%

Table 5

Test Circuit

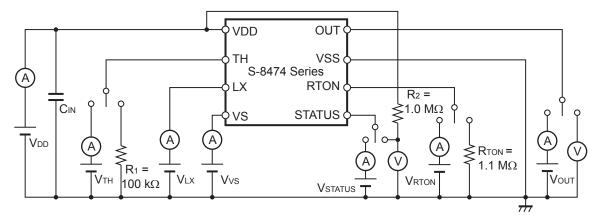


Figure 4

Operation

Remark Refer to "■ Standard Circuit".

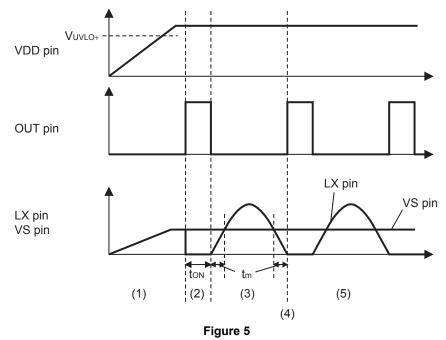
1. Basic operation

1.1 OUT pin output

- (1) After power-on, the power supply voltage (V_{DD}) becomes the UVLO release voltage (V_{UVLO+}) or higher, and a certain period of time elapses. And then, V_{DD} ("H") is output from the OUT pin and an oscillation is started.
- (2) V_{DD} output from the OUT pin is maintained only for t_{ON} time (t_{ON}) determined by the resistance connected to the RTON pin.
- (3) After the elapse of t_{ON} , V_{SS} ("L") is output from the OUT pin.

The IC holds the period from when V_{SS} is output to when the LX pin voltage exceeds the VS pin voltage (t_m). After that, the OUT pin maintains V_{SS} from when the LX pin voltage drops below the VS pin voltage to when t_m finishes.

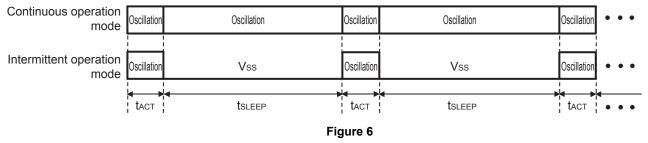
- (4) After t_m finishes, V_{DD} is output from the OUT pin.
- (5) The operations of (2) to (4) are repeated.



1.2 Operation modes

The S-8474 Series has two operation modes: continuous operation mode and intermittent operation mode. As shown in **Figure 6**, the active time (t_{ACT}) and the sleep time (t_{SLEEP}) are repeated alternately. In the continuous operation mode, the OUT pin output oscillates during both t_{ACT} and t_{SLEEP} . In the intermittent operation mode, the OUT pin output oscillates during t_{ACT} , and V_{SS} is output during t_{SLEEP} .

Transition of the two operation modes is realized by a reception detection circuit. The reception detection circuit compares peak values of the LX pin voltage waveform and detects a change for approximately 3 ms to 5 ms after t_{ACT} initiation. When there is no change in the peak values of the LX pin voltage waveform, the reception detection circuit changes to a non-detection status, and the mode transitions to the intermittent operation mode. When there is a change, the reception detection circuit changes to a detection status, and the mode transitions to the continuous operation mode.



2. UVLO function

The S-8474 Series has a UVLO (under voltage lock out) circuit for avoiding IC malfunctions due to a transient status at power-on or instantaneous power supply voltage drop. If V_{DD} decreases to the UVLO detection voltage (V_{UVLO_-}), the S-8474 Series becomes a standby status. In the standby status, the operations of all internal circuits other than the UVLO circuit are stopped, reducing the current consumption. V_{SS} is output from the OUT pin and the STATUS pin changes to "High-Z".

Also, between V_{UVLO+} and V_{UVLO-} , there is a hysteresis width for avoiding malfunctions due to generation of noise etc. in the input voltage.

3. t_{ON} time setting

 t_{ON} time can be set to any given value by connecting an external resistor between the RTON pin and the VSS pin. The resistance of the external resistor (R_{TON}) is calculated by the following equation. Set R_{TON} in the range of 500 k Ω to 2.0 M Ω .

 t_{ON} [µs] = 3.86 × R_{TON} [MΩ] + 0.14

4. Over temperature protection function

By connecting an external thermistor to the TH pin, a potential over temperature status (due to external component heat generation) can be prevented. When the resistance of the thermistor decreases to the resistance calculated by the following equation (R_{TH}) due to external component heat generation, an over temperature protection function begins to operate, and then the mode changes to a high temperature protection mode. In the high temperature protection mode, the OUT pin output is latched to V_{SS} . However, the other internal circuits operate during the period unlike the standby status, so caution should be exercised. The IC is reset by decreasing V_{DD} to $V_{UVLO_{-}}$ or lower.

$$\mathsf{R}_{\mathsf{TH}} \left[\mathsf{k}\Omega \right] = \frac{\mathsf{R}_{\mathsf{LIN}} \left[\mathsf{k}\Omega \right] \times \mathsf{V}_{\mathsf{TSD}} \left[\mathsf{V} \right]}{(2.5 - \mathsf{V}_{\mathsf{TSD}} \left[\mathsf{V} \right])}$$

Connect a thermistor between the TH pin and the VSS pin. An NTC thermistor of R = 100 k Ω at Ta = +25°C (R₂₅) is recommended. For example, if an NTC thermistor of R₂₅ and B_{25/50} (B constant (25°C/50°C)) = 4250 K is used, the over temperature protection function begins to operate at approximately +70°C when V_{TSD} = 0.500 V. When not using the over temperature protection function, set the TH pin open or connect a resistor of 100 k Ω or greater.

5. Status display function

The S-8474 Series can display the operation status by connecting an external LED to the STATUS pin.

In a continuous operation mode, an Nch driver of the STATUS pin is turned on, "L" is output from the STATUS pin, and the external LED is lighted on. In an intermittent operation mode, the Nch driver of the STATUS pin is turned off, the STATUS pin changes to "High-Z", and the external LED is lighted off.

In a high temperature protection mode, the Nch driver of the STATUS pin is turned on and off repeatedly. Also, "L" and "High-Z" are output from the STATUS pin, the operation is repeated with the STATUS pin blinking cycle (t_{SW}), and the external LED is blinked. When not using the status display function, set the STATUS pin open.

Standard Circuit

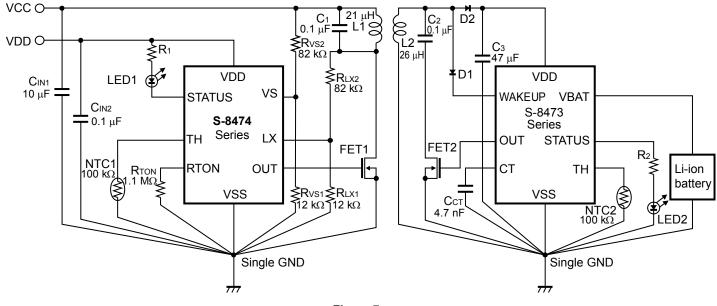


Figure 7

Caution The above connection diagram and constants will not guarantee successful operation. Perform thorough evaluation using the actual application to set the constants.

Precautions

- For VCC, do not use a power supply which might cause frequency component amplitude of 1 kHz to 110 kHz (LC resonant frequency). It may result in a malfunction.
- To protect from overheat, be sure to connect an NTC thermistor to the TH pin for its use.
- Mount an external resistor, an Nch power MOS FET, etc. as close as possible to the IC so as to make the single GND.
- When the wiring impedance is high, the operation may be unstable due to the resonance circuit or the noise caused by switching of the output pin, so mount the input capacitor (C_{IN2}) as close as possible to the IC.
- The application conditions for the input voltage, output voltage, and load current should not exceed the package power dissipation.
- Do not apply an electrostatic discharge to this IC that exceeds the performance ratings of the built-in electrostatic protection circuit.
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Characteristics (Typical Data)

1. Current consumption

1. 1 I_{SS1} vs. V_{DD}

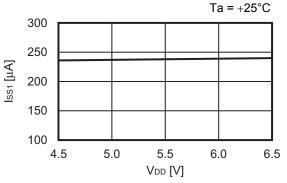
Iste [µA]

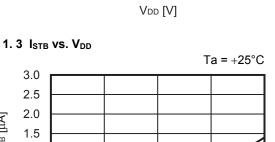
1.0

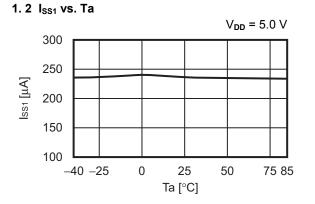
0.5

0.0

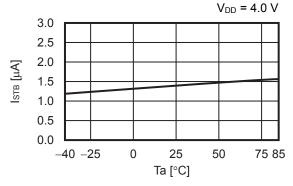
0.0











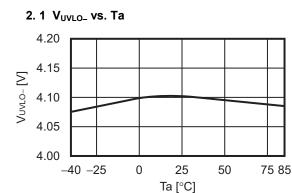


2.0

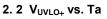
VDD [V]

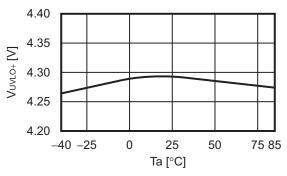
3.0

4.0



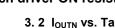
1.0

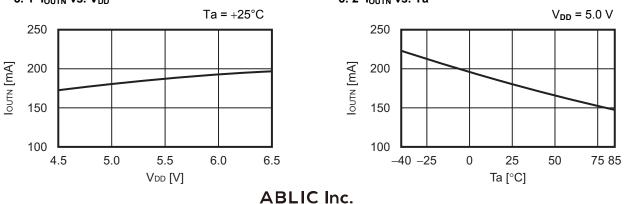


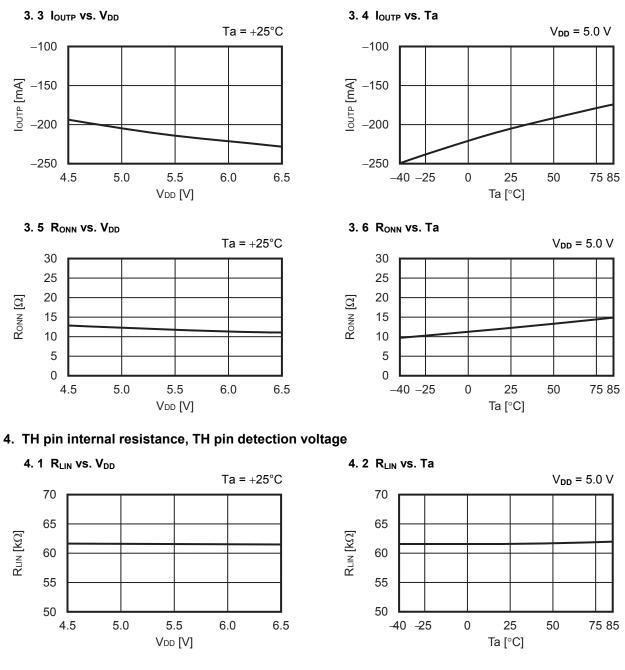


3. Out pin sink current, OUT pin source current, Nch driver ON resistance for STATUS pin











0.550

0.530

 \geq 0.510

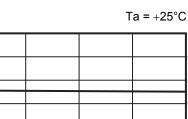
∑⁰ 0.490

0.470

0.450

4.5

5.0



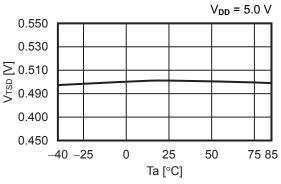
5.5

VDD [V]

6.0







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6.5

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 R_{TON} = 1.0 M Ω , V_{DD} = 5.0 V

50

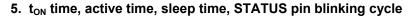
75 85

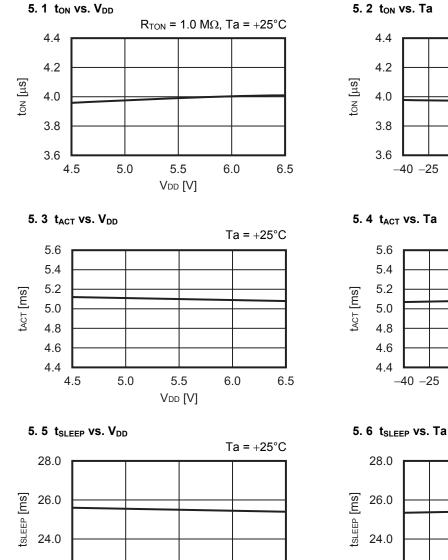
75 85

75 85

 V_{DD} = 5.0 V

 V_{DD} = 5.0 V





 26.0
 24.0

 22.0
 -40 -25
 0

 25
 50

 Ta [°C]

0

25

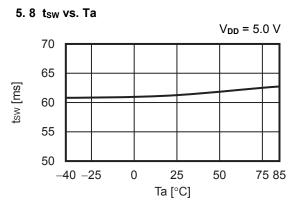
Ta [°C]

50

0

25

Ta [°C]





4.5

5.0

5.5

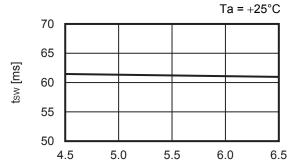
VDD [V]

Vdd [V]

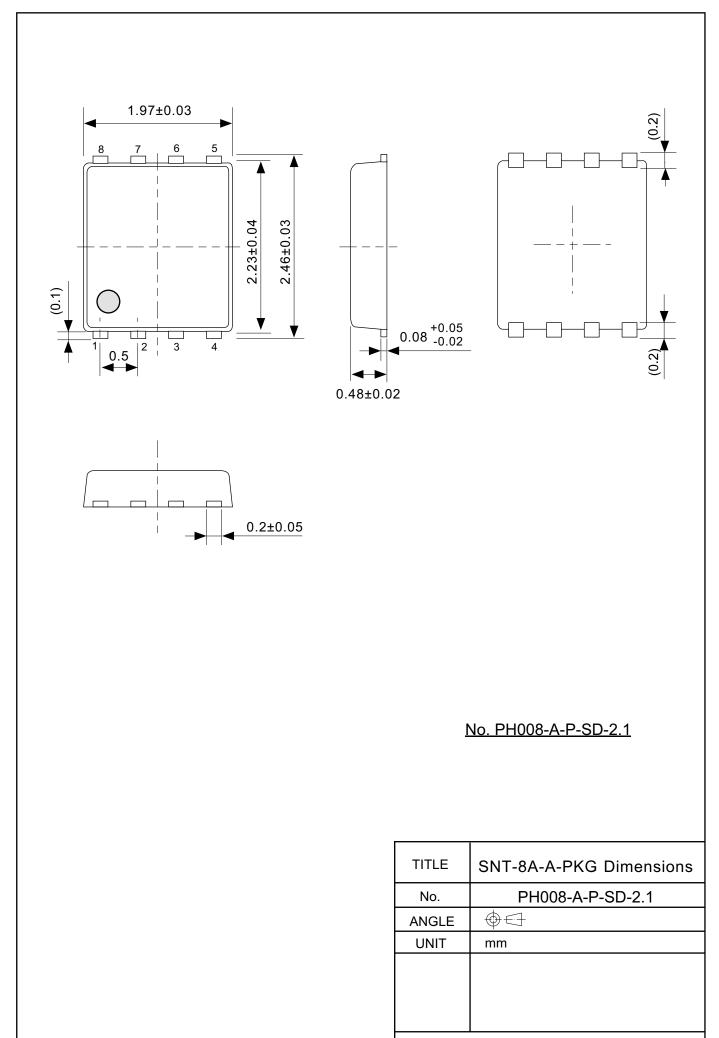
6.0

6.5

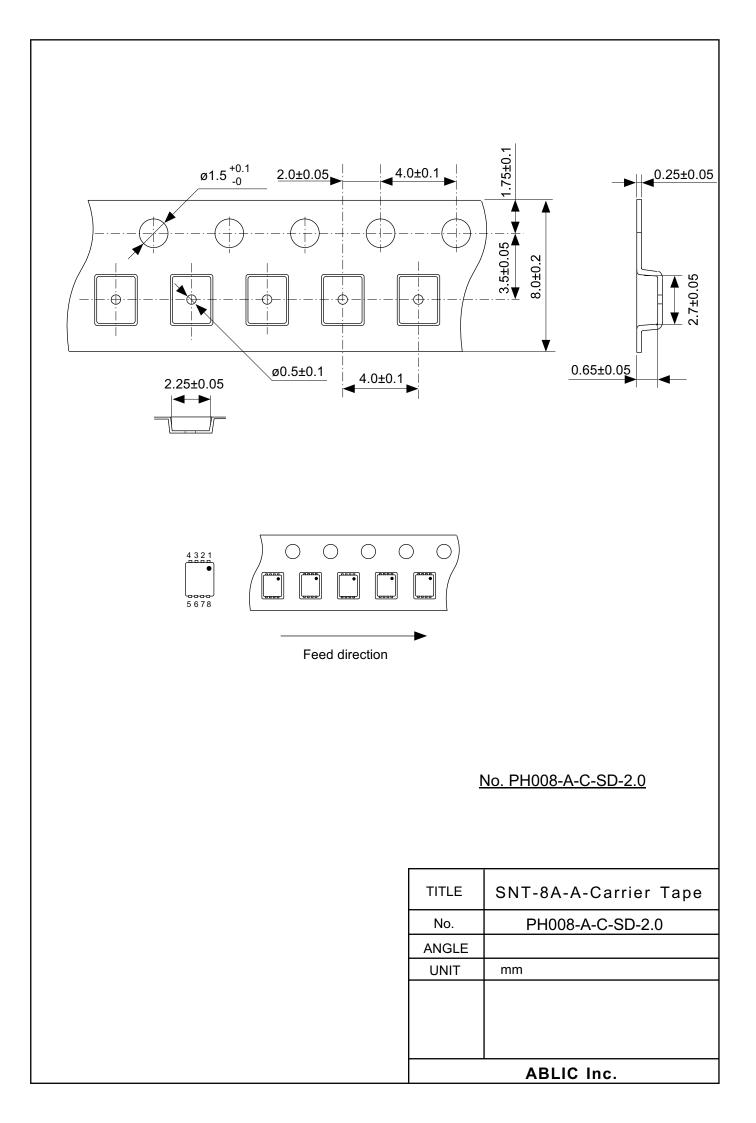
22.0

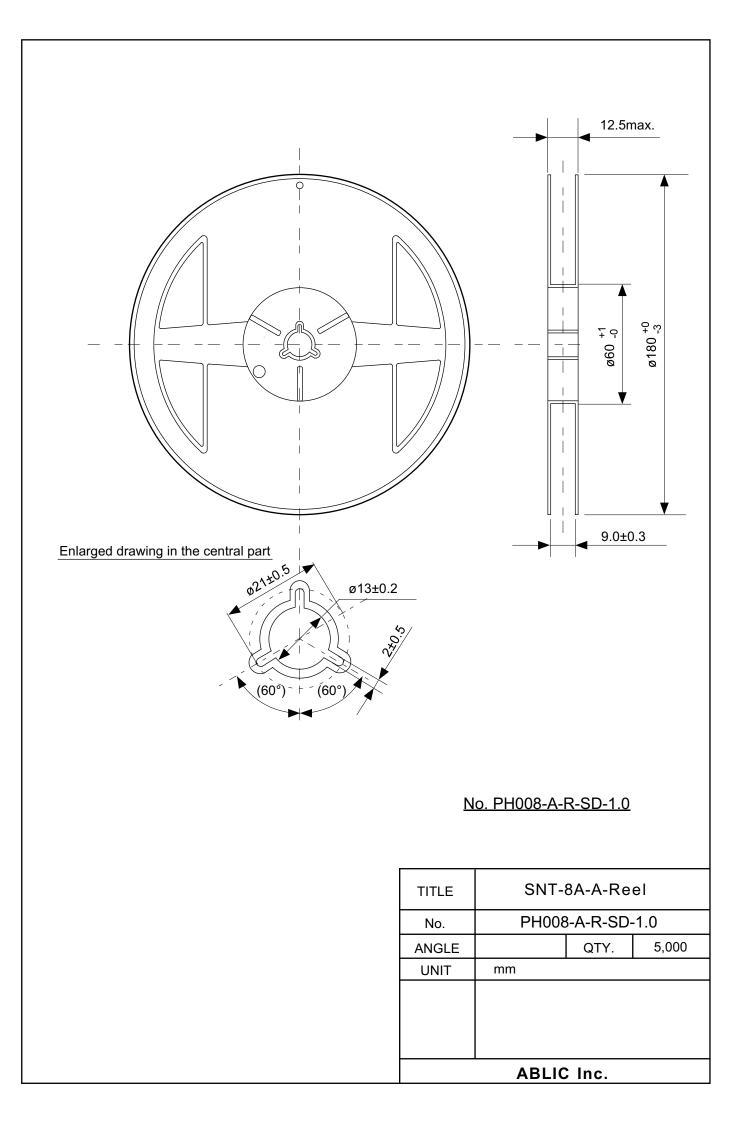


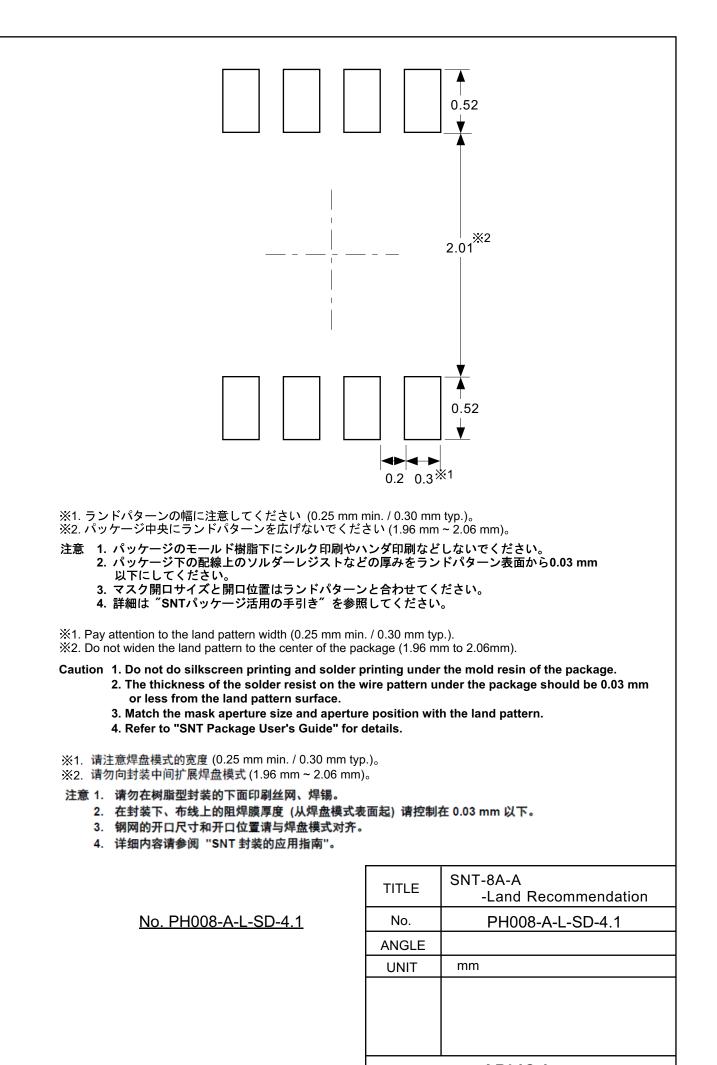




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